



Solid State Relay  
OCMOS FET

# PS7200R-1A

**4-PIN SOP, 1.1 pF LOW OUTPUT CAPACITANCE  
1-ch Optical Coupled MOS FET**

—NEPOC Series—

## DESCRIPTION

The PS7200R-1A is a low output capacitance solid state relay containing a GaAs LED on the light emitting side (input side) and MOS FETs on the output side.

It is suitable for high-frequency signal control, due to its low  $C \times R$ , low output capacitance, and low off-state leakage current.

## FEATURES

- Low  $C \times R$  ( $C \times R = 11 \text{ pF} \cdot \Omega$ )
- Low output capacitance ( $C_{\text{out}} = 1.1 \text{ pF TYP.}$ )
- 1 channel type (1 a output)
- Designed for AC/DC switching line changer
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- High isolation voltage ( $BV = 1\,500 \text{ Vr.m.s.}$ )
- Low offset voltage
- Ordering number of taping product : PS7200R-1A-E3, E4: 900 pcs/reel  
: PS7200R-1A-F3, F4: 3 500 pcs/reel

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- Pb-Free product

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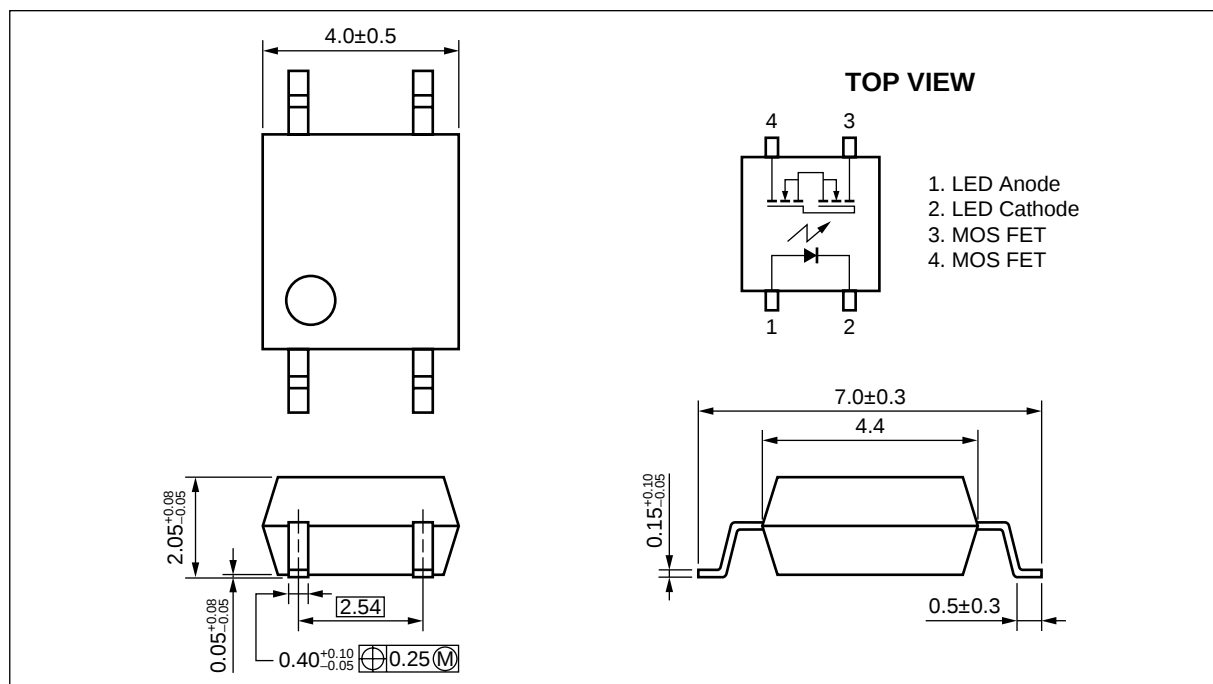
- Safety standards
  - UL approved: File No. E72422
  - BSI approved: No. 8241/8242

## APPLICATIONS

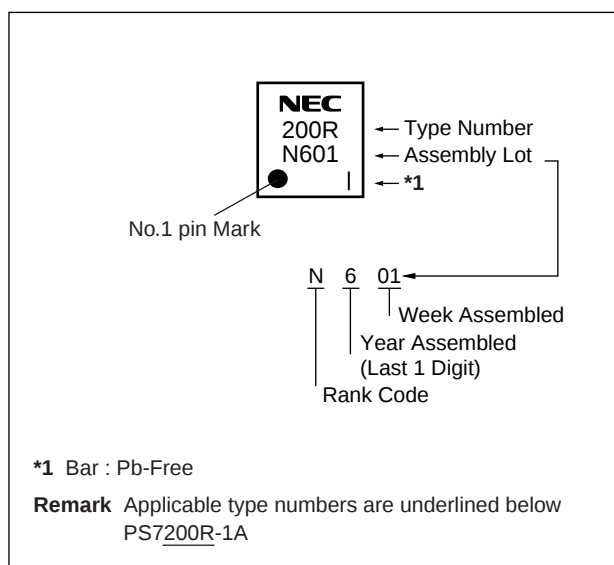
- Measurement equipment

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**PACKAGE DIMENSIONS (UNIT: mm)**



**<R> MARKING EXAMPLE (LASER MARKING)**



**<R> ORDERING INFORMATION**

| Part Number   | Order Number    | Solder Plating Specification | Packing Style                | Safety Standard Approval                | Application Part Number <sup>*1</sup> |
|---------------|-----------------|------------------------------|------------------------------|-----------------------------------------|---------------------------------------|
| PS7200R-1A    | PS7200R-1A-A    | Pb-Free                      | Magazine case 100 pcs        | Standard products<br>(UL, BSI approved) | PS7200R-1A                            |
| PS7200R-1A-E3 | PS7200R-1A-E3-A |                              | Embossed Tape 900 pcs/reel   |                                         |                                       |
| PS7200R-1A-E4 | PS7200R-1A-E4-A |                              |                              |                                         |                                       |
| PS7200R-1A-F3 | PS7200R-1A-F3-A |                              | Embossed Tape 3 500 pcs/reel |                                         |                                       |
| PS7200R-1A-F4 | PS7200R-1A-F4-A |                              |                              |                                         |                                       |

**\*1** For the application of the Safety Standard, following part number should be used.

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)**

| Parameter                       |                                                        | Symbol           | Ratings     | Unit    |
|---------------------------------|--------------------------------------------------------|------------------|-------------|---------|
| Diode                           | Forward Current (DC)                                   | I <sub>F</sub>   | 50          | mA      |
|                                 | Reverse Voltage                                        | V <sub>R</sub>   | 5.0         | V       |
|                                 | Power Dissipation                                      | P <sub>D</sub>   | 50          | mW      |
|                                 | Peak Forward Current <sup>*1</sup>                     | I <sub>FP</sub>  | 1           | A       |
| MOS FET                         | Break Down Voltage                                     | V <sub>L</sub>   | 40          | V       |
|                                 | Continuous Load Current                                | I <sub>L</sub>   | 120         | mA      |
|                                 | Pulse Load Current <sup>*2</sup><br>(AC/DC Connection) | I <sub>LP</sub>  | 240         | mA      |
|                                 | Power Dissipation                                      | P <sub>D</sub>   | 200         | mW      |
| Isolation Voltage <sup>*3</sup> |                                                        | BV               | 1 500       | Vr.m.s. |
| Total Power Dissipation         |                                                        | P <sub>T</sub>   | 250         | mW      |
| Operating Ambient Temperature   |                                                        | T <sub>A</sub>   | -40 to +85  | °C      |
| Storage Temperature             |                                                        | T <sub>stg</sub> | -40 to +100 | °C      |

**\*1** PW = 100 μs, Duty Cycle = 1%

**\*2** PW = 100 ms, 1 shot

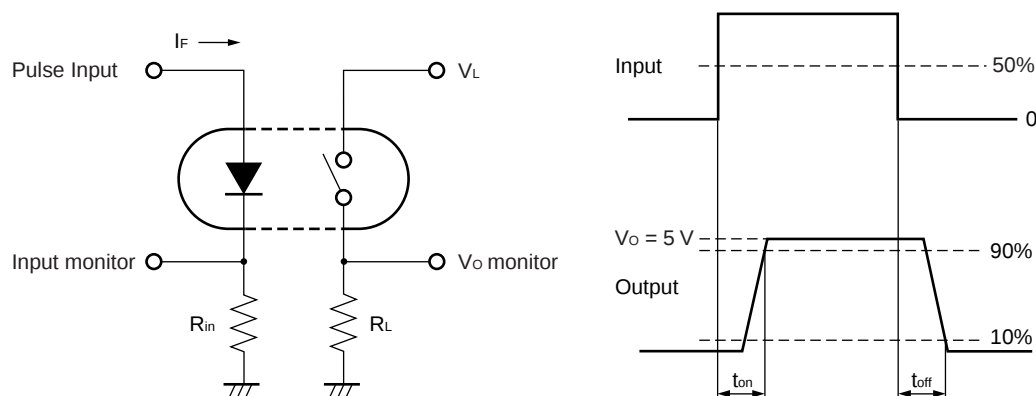
**\*3** AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output.  
Pins 1-2 shorted together, 3-4 shorted together.

**RECOMMENDED OPERATING CONDITIONS ( $T_A = 25^\circ\text{C}$ )**

| Parameter             | Symbol | MIN. | TYP. | MAX. | Unit |
|-----------------------|--------|------|------|------|------|
| LED Operating Current | $I_F$  | 2    | 10   | 20   | mA   |
| LED Off Voltage       | $V_F$  | 0    |      | 0.5  | V    |

**ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )**

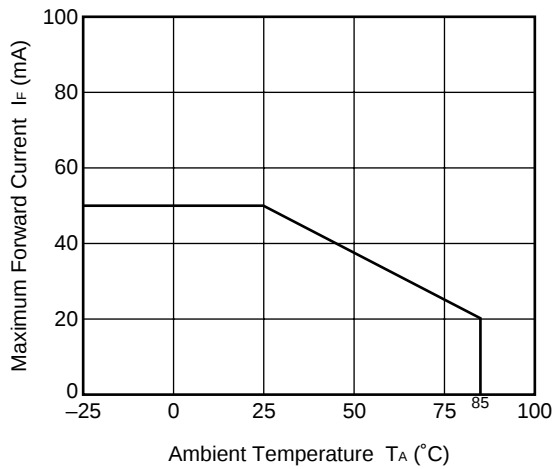
| Parameter |                               | Symbol            | Conditions                                                                                        | MIN.   | TYP. | MAX. | Unit          |
|-----------|-------------------------------|-------------------|---------------------------------------------------------------------------------------------------|--------|------|------|---------------|
| Diode     | Forward Voltage               | $V_F$             | $I_F = 10\text{ mA}$                                                                              |        | 1.2  | 1.4  | V             |
|           | Reverse Current               | $I_R$             | $V_R = 5\text{ V}$                                                                                |        |      | 5.0  | $\mu\text{A}$ |
| MOS FET   | Off-state Leakage Current     | $I_{\text{Leak}}$ | $V_D = 40\text{ V}$                                                                               |        |      | 10   | nA            |
|           | Output Capacitance            | $C_{\text{out}}$  | $V_D = 0\text{ V}$ , $f = 1\text{ MHz}$                                                           |        | 1.1  |      | pF            |
| Coupled   | LED On-state Current          | $I_{\text{Fon}}$  | $I_L = 120\text{ mA}$                                                                             |        |      | 2.0  | mA            |
|           | On-state Resistance           | $R_{\text{on1}}$  | $I_F = 10\text{ mA}$ , $I_L = 10\text{ mA}$                                                       |        | 10   | 12.5 | $\Omega$      |
|           |                               | $R_{\text{on2}}$  | $I_F = 10\text{ mA}$ , $I_L = 120\text{ mA}$ , $t \leq 10\text{ ms}$                              |        | 11   | 14   |               |
|           | Turn-on Time <sup>*1,2</sup>  | $t_{\text{on}}$   | $I_F = 10\text{ mA}$ , $V_O = 5\text{ V}$ , $R_L = 500\text{ }\Omega$ ,<br>$PW \geq 10\text{ ms}$ |        | 0.03 | 0.5  | ms            |
|           | Turn-off Time <sup>*1,2</sup> | $t_{\text{off}}$  |                                                                                                   |        | 0.3  | 1.0  |               |
|           | Isolation Resistance          | $R_{\text{I-O}}$  | $V_{\text{I-O}} = 1.0\text{ kV}_{\text{DC}}$                                                      | $10^9$ |      |      | $\Omega$      |
|           | Isolation Capacitance         | $C_{\text{I-O}}$  | $V = 0\text{ V}$ , $f = 1\text{ MHz}$                                                             |        | 0.3  |      | pF            |

**\*1 Test Circuit for Switching Time****\*2 The turn-on time and turn-off time are specified as input-pulse width  $\geq 10\text{ ms}$ .**

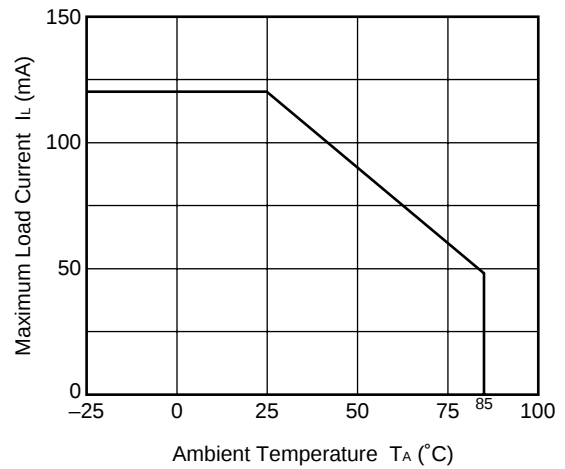
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

**TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)**

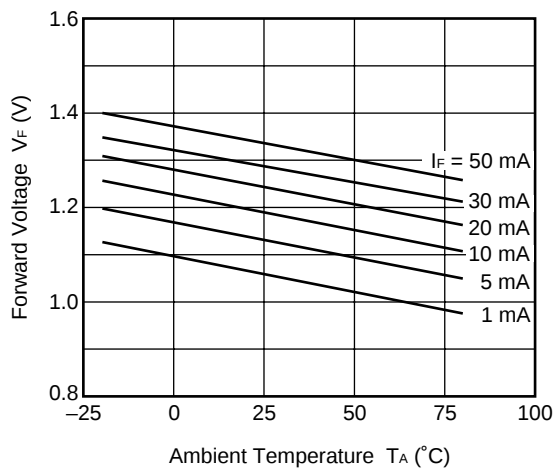
MAXIMUM FORWARD CURRENT vs.  
AMBIENT TEMPERATURE



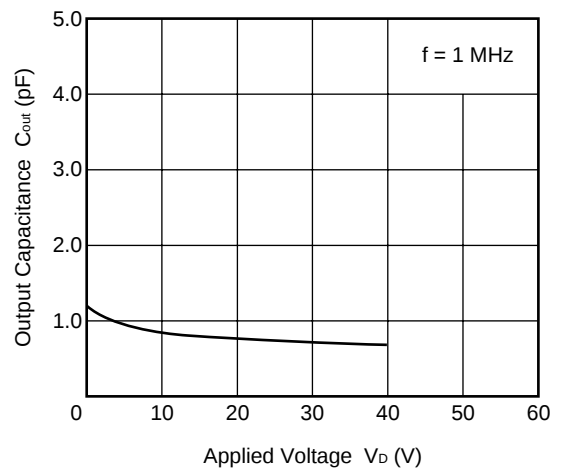
MAXIMUM LOAD CURRENT vs.  
AMBIENT TEMPERATURE



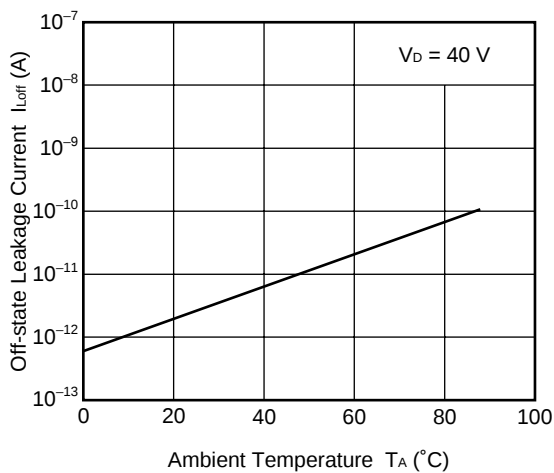
FORWARD VOLTAGE vs.  
AMBIENT TEMPERATURE



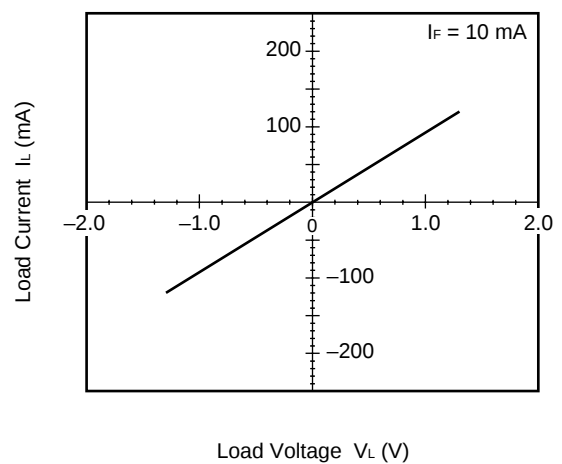
OUTPUT CAPACITANCE vs.  
APPLIED VOLTAGE



OFF-STATE LEAKAGE CURRENT vs.  
AMBIENT TEMPERATURE

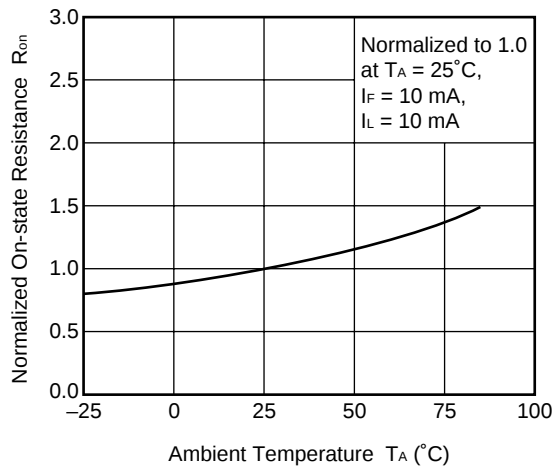


LOAD CURRENT vs. LOAD VOLTAGE

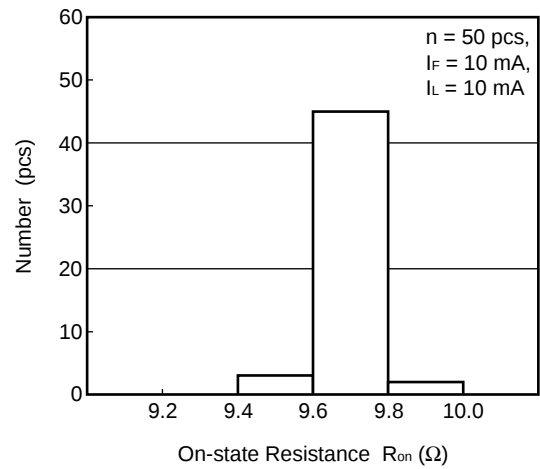


**Remark** The graphs indicate nominal characteristics.

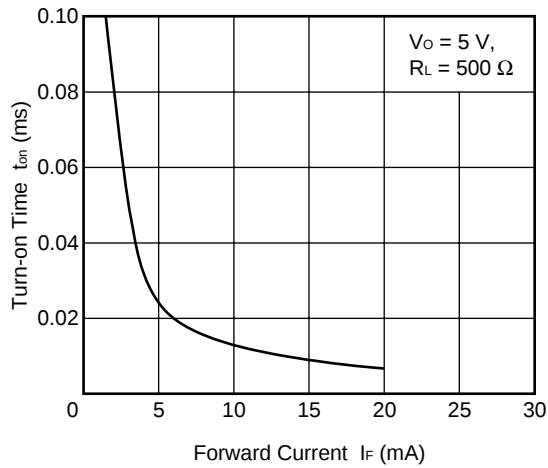
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



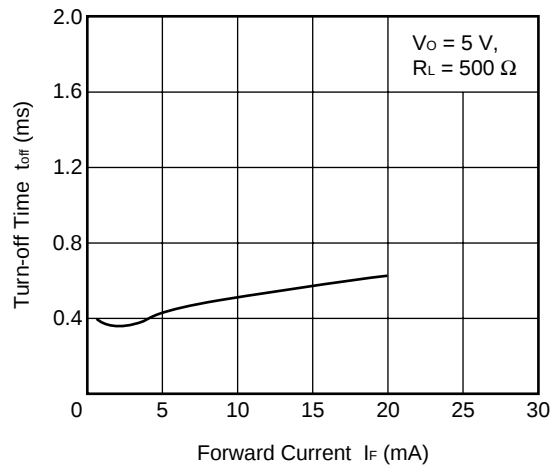
ON-STATE RESISTANCE DISTRIBUTION



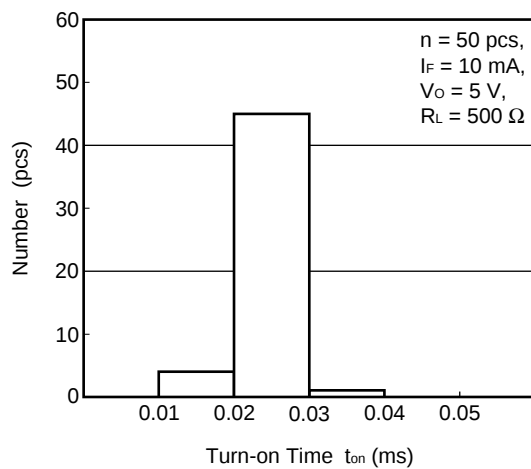
TURN-ON TIME vs. FORWARD CURRENT



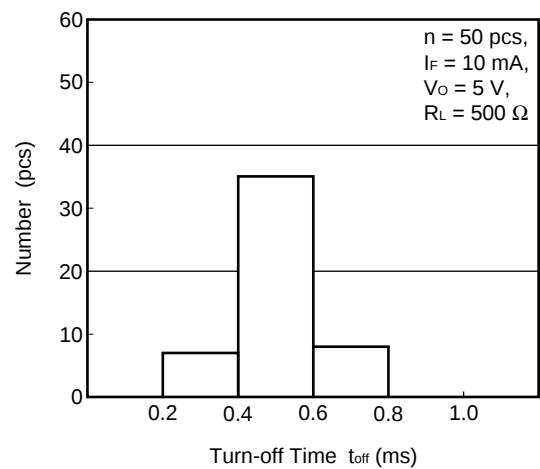
TURN-OFF TIME vs. FORWARD CURRENT



TURN-ON TIME DISTRIBUTION

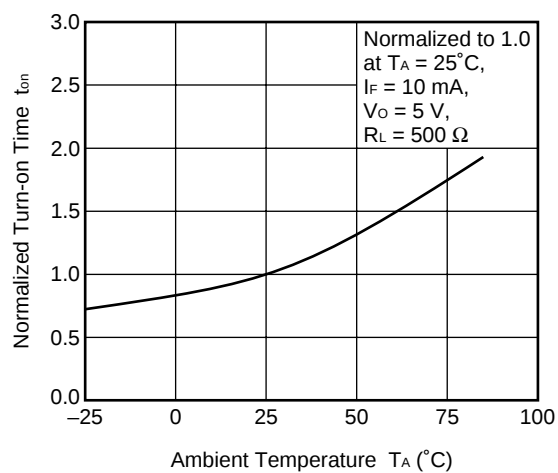


TURN-OFF TIME DISTRIBUTION

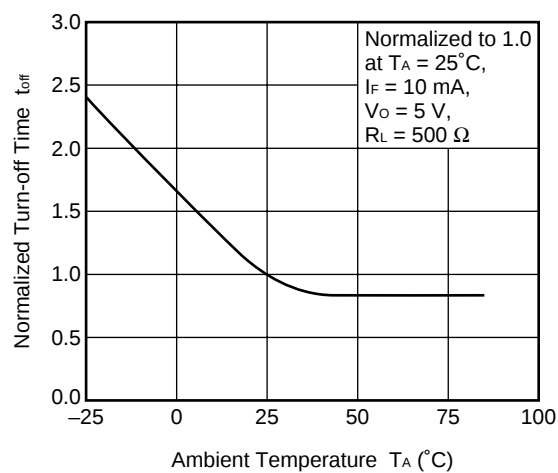


**Remark** The graphs indicate nominal characteristics.

**NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE**



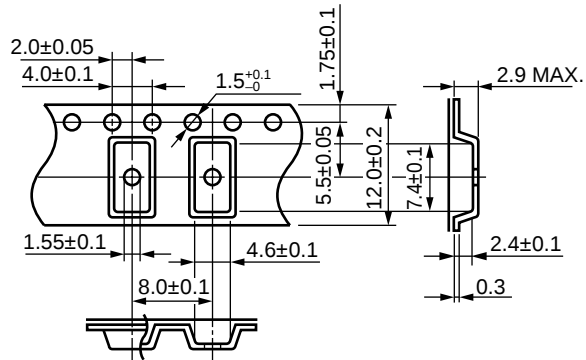
**NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE**



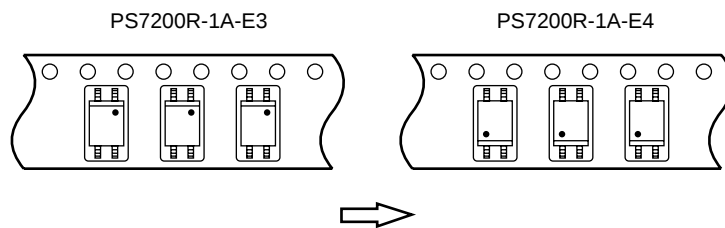
**Remark** The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

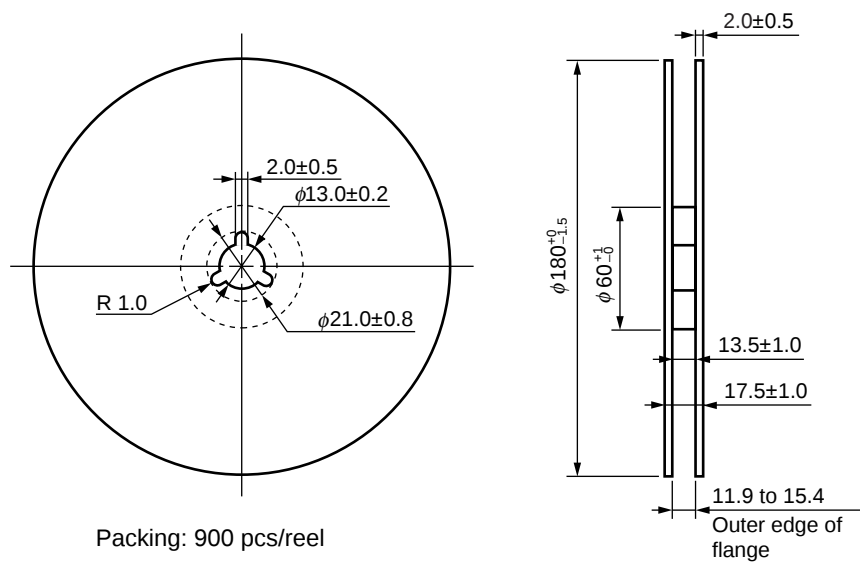
Outline and Dimensions (Tape)



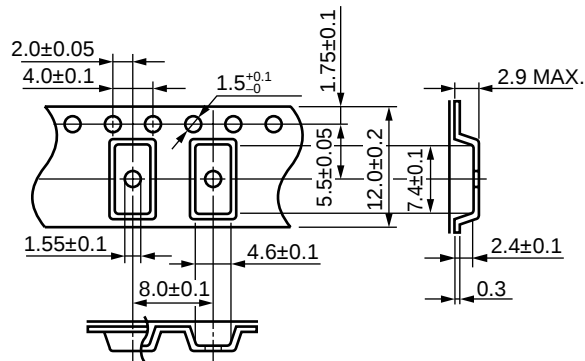
Tape Direction



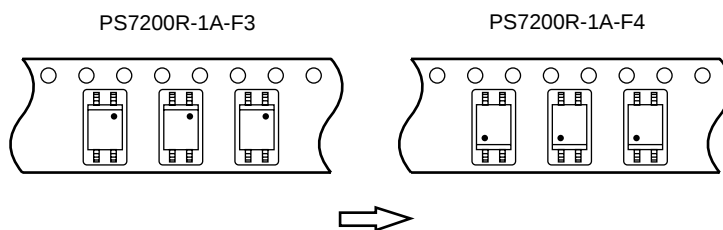
Outline and Dimensions (Reel)



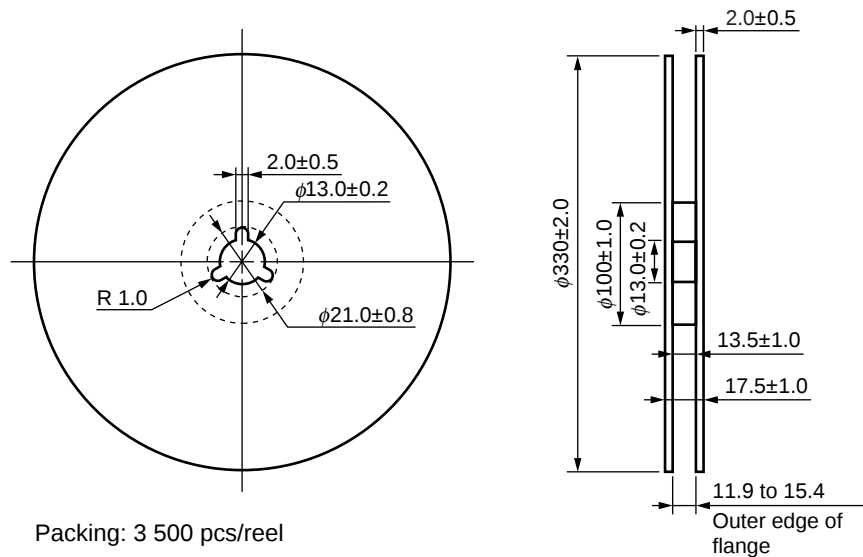
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)

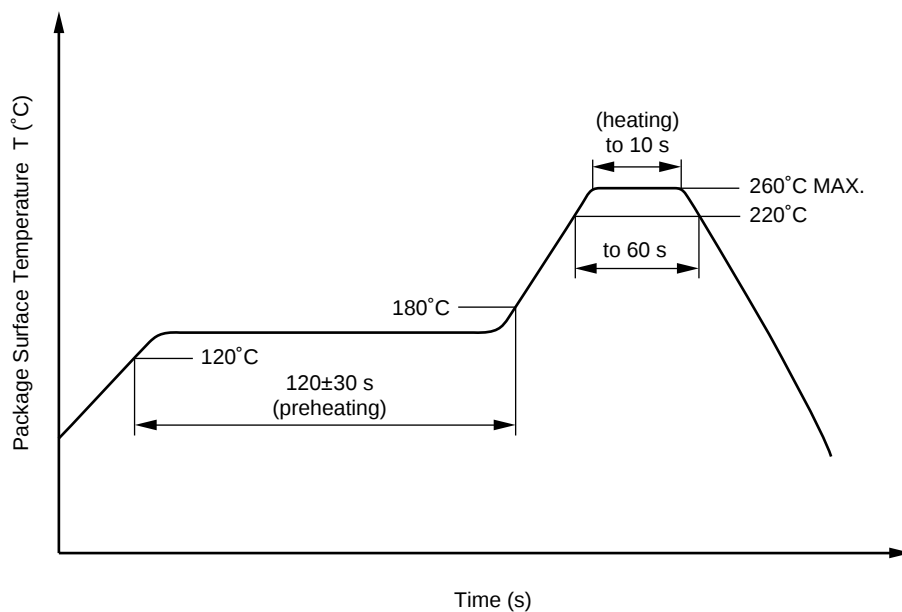


## RECOMMENDED SOLDERING CONDITIONS

### (1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

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### (3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

### (4) Cautions

- Fluxes  
Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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**USAGE CAUTIONS**

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <div data-bbox="177 230 288 275" style="border: 1px solid black; padding: 2px; display: inline-block;"><b>Caution</b></div> <div data-bbox="300 241 448 264">GaAs Products</div> | <p>This product uses gallium arsenide (GaAs).<br/>GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> <li>• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. <ol style="list-style-type: none"> <li>1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> <li>2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li> </ol> </li> <li>• Do not burn, destroy, cut, crush, or chemically dissolve the product.</li> <li>• Do not lick the product or in any way allow it to enter the mouth.</li> </ul> |
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► For further information, please contact

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